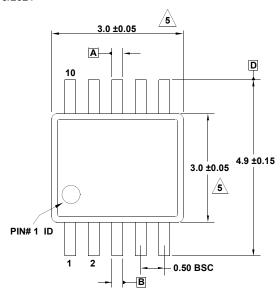
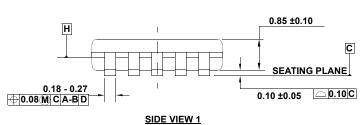
Plastic Packages for Integrated Circuits

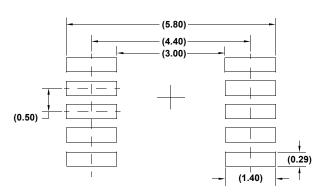
Package Outline Drawing

M10.118 10 Lead Mini Small Outline Plastic Package Rev 2, 5/2021

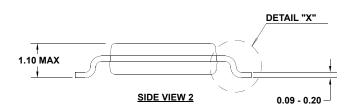


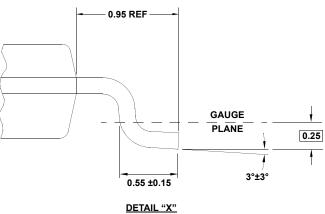
TOP VIEW





TYPICAL RECOMMENDED LAND PATTERN





NOTES:

- 1. Dimensions are in millimeters.
- Dimensioning and tolerancing conform to JEDEC MO-187-BA and AMSEY14.5m-1994.
- 3. Plastic or metal protrusions of 0.15mm max per side are not included.
- Plastic interlead protrusions of 0.15mm max per side are not included.
- 5. Dimensions are measured at Datum Plane "H".
- 6. Dimensions in () are for reference only.

